



August 26, 2025

88th Issuance of Domestic Unsecured Straight Bonds

ACOM CO., LTD. has reached a decision to make its 88th issuance of domestic unsecured straight bonds, as outlined below. The funds procured through this issuance will be used for partial repayment of long-term borrowings.

Name of issuance	ACOM CO., LTD. 88 th issuance of domestic unsecured straight bonds
Total value	10 billion yen
Interest rate	1.591% annually
Individual bond value	100 million yen
Issue price	Face value 100 yen
Redemption price	Face value 100 yen
Application period	August 26, 2025
Payment date	September 1, 2025
Maturation date	August 30, 2030
Application of funds procured	Partial repayment of long-term borrowings
Trustee	Mitsubishi UFJ Morgan Stanley Securities Co., Ltd. SMBC Nikko Securities Inc. Daiwa Securities Co. Ltd. Nomura Securities Co., Ltd.
Transfer agent	MUFG Bank, Ltd.
Credit ratings	Rating and Investment Information, Inc.: AA-

ACOM CO., LTD.

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